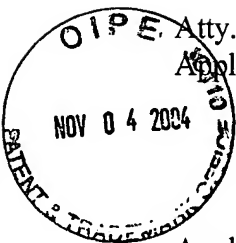


IFW \$



Atty. Docket No. CPAC 1029-6
Appl. No. 10/681,747

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos)
) Examiner: Roy Karl Potter
Application No.: 10/681,747)
) Group Art Unit: 2822
Filed: October 8, 2003)
) Date: November 1, 2004
Title: **Semiconductor multi-package module**)
 having inverted second package)
 and including additional die or stacked)
 package on second package)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 1, 2004.

Signed Paula Faulk Hurley
Paula Faulk Hurley

PRELIMINARY AMENDMENT
AND RESPONSE TO RESTRICTION REQUIREMENT

Dear Sir:

Responsive to the Office action mailed September 29, 2004 (restriction only), Applicants elect:

Group I, claims 1 - 20, 41 and 42
for prosecution in this application.

Preliminarily, kindly amend the application as follows:

Amendments to the Specification begin on page 2 of this paper.

There are no amendments to the claims. A **Listing of Claims** is included for the Examiner's convenience, beginning on page 5 of this paper.

Amendments to the Drawings begin on page 10 of this paper and include both attached replacement sheets and annotated sheets showing changes.

Remarks begin on page 11 of this paper.

An **Appendix** including amended drawing figures is attached following page 12 of this paper.